

# 1.5A, 200V - 1000V Surface Mount Rectifiers

#### **FEATURES**

- Ideal for automated placement
- · Compact package size
- High surge current capability
- Low power loss, high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

Λ	D	DI	^	Λ	TI	M	C

- High frequency rectification
- · Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication.

#### **MECHANICAL DATA**

- Case: SOD-123W
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 19mg (approximately)

KEY PARAMETERS							
PARAMETER	VALUE	UNIT					
$I_{F(AV)}$	1.5	Α					
$V_{RRM}$	200 - 1000	V					
I <sub>FSM</sub>	50	Α					
$T_{JMAX}$	175	°C					
Package	SOD-123W						
Configuration	Single die	!					





**SOD-123W** 

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)							
DADAMETED	CYMPOL	S15	S15	<b>S15</b>	S15	<b>S15</b>	
PARAMETER	SYMBOL	DLW	GLW	JLW	KLW	MLW	UNIT
Marking and on the device		15	15	15	15	15	
Marking code on the device		DLW	GLW	JLW	KLW	MLW	
Repetitive peak reverse voltage	$V_{RRM}$	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	200	400	600	800	1000	V
Forward current	I <sub>F(AV)</sub>			1.5			Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>			50			Α
Junction temperature	$T_J$		-55 to +175				°C
Storage temperature	T <sub>STG</sub>		-5	55 to +17	75		°C

1



THERMAL PERFORMANCE								
PARAMETER	SYMBOL	LIMIT	UNIT					
Junction-to-lead thermal resistance	$R_{\Theta JL}$	29	°C/W					
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	85	°C/W					
Junction-to-case thermal resistance	$R_{ ext{ hetaJC}}$	31	°C/W					

Thermal Performance Note: Units mounted on recommended PCB (5mm\*5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT		
	I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C		0.94	1.05	V		
Forward voltage per diode (1)	I <sub>F</sub> = 1.5A, T <sub>J</sub> = 25°C	V <sub>F</sub>	0.98	1.1	V		
	I <sub>F</sub> = 1A, T <sub>J</sub> = 125°C		0.81	1	V		
	I <sub>F</sub> = 1.5A, T <sub>J</sub> = 125°C		0.87	1.05	V		
Deverge everent @ reted // nor diade (2)	T <sub>J</sub> = 25°C	1	0.06	1	μA		
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 125°C	l <sub>R</sub>	6.06	100	μΑ		
Junction Capacitance	1 MHz, V <sub>R</sub> =4.0V	CJ	10	-	ρF		

#### Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION							
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING		
S15xLW (Note 1,2)		RV		SOD-123W	3,000 / 7" Reel		
	Н	RQ	G	SOD-123W	10,000 / 13" Reel		

## Notes:

- 1. "x" defines voltage from 200V (S15DLW) to 1000V (S15MLW)
- 2. Whole series with green compound (halogen-free)

EXAMPLE P/N							
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION		
S15MLWHRVG	S15MLW	Н	RV	G	AEC-Q101 qualified Green compound		

2



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

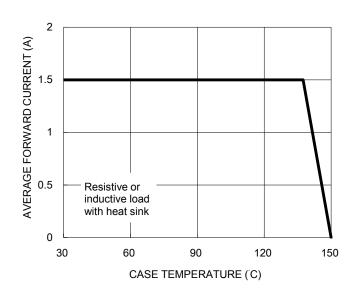


Fig.2 Typical Junction Capacitance

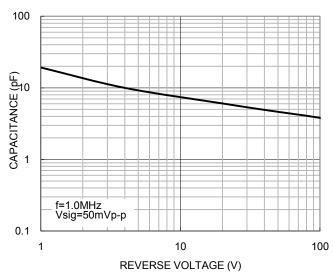


Fig.3 Typical Reverse Characteristics

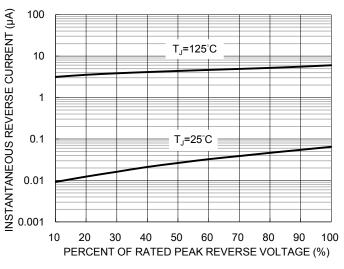
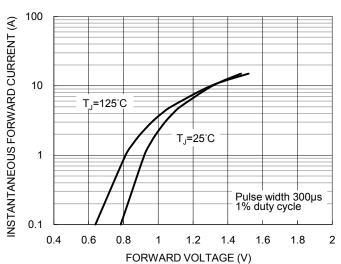


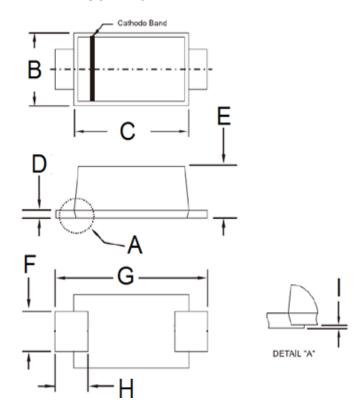
Fig.4 Typical Forward Characteristics





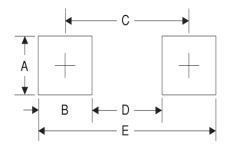
## **PACKAGE OUTLINE DIMENSIONS**

**SOD-123W** 



DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
В	1.70	1.90	0.067	0.075	
С	2.60	2.90	0.102	0.114	
D	0.10	0.22	0.004	0.009	
Е	0.90	1.02	0.035	0.040	
F	0.90	1.05	0.035	0.041	
G	3.60	3.80	0.142	0.150	
Н	0.50	0.85	0.020	0.033	
Ī	0.00	0.10	0.000	0.004	

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	1.4	0.055
В	1.2	0.047
С	3.1	0.122
D	1.9	0.075
Е	4.3	0.169

# **MARKING DIAGRAM**



P/N = Marking Code G = Green Compound

YW = Date Code F = Factory Code



Taiwan Semiconductor

### **Notice**

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.